



DCR2630Y52

Phase Control Thyristor

DS5901-3 March 2013 (LN30238)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V _{DRM} and V _{RRM} V	Conditions
DCR2630Y52* DCR2630Y50 DCR2630Y48	5200 5000 4800	$\begin{split} T_{vj} &= \text{-}40^{\circ}\text{C to 125}^{\circ}\text{C}, \\ I_{DRM} &= I_{RRM} = 200\text{mA}, \\ V_{DRM}, V_{RRM} t_p &= 10\text{ms}, \\ V_{DSM} \& V_{RSM} &= \\ V_{DRM} \& V_{RRM} + 100V \\ respectively \end{split}$

Lower voltage grades available. * 5000V @ -40° C, 5200V °0° C

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR2630Y52

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

KEY PARAMETERS

V_{DRM}	5200V
I _{T(AV)}	2630A
I _{TSM}	36700A
dV/dt*	1500V/μs
dl/dt	300A/µs

* Higher dV/dt selections available

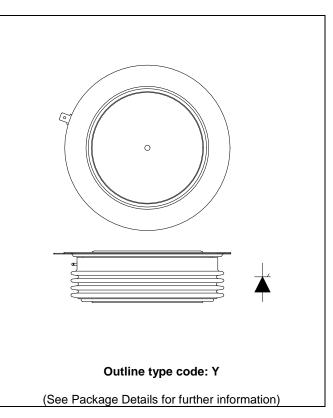


Fig. 1 Package outline





CURRENT RATINGS

$T_{case} = 60$ °C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
I _{T(AV)} Mean on-state current		Half wave resistive load		А
I _{T(RMS)}	RMS value	-	4131	А
I _T	Continuous (direct) on-state current	-	3810	А

SURGE RATINGS

Symbol Parameter		Test Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	10ms half sine, T _{case} = 125°C	36.7	kA
l ² t	I ² t for fusing	$V_R = 0$	6.73	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	Test Conditions		Max.	Units
R _{th(j-c)}	Thermal resistance – junction to case	Double side cooled	DC	-	0.00835	°C/W
		Single side cooled	Anode DC	-	0.0134	°C/W
			Cathode DC	1	0.023	°C/W
R _{th(c-h)}	Thermal resistance – case to heatsink	Clamping force 54kN Double side		-	0.002	°C/W
		(with mounting compound) Single side		1	0.004	°C/W
T_{vj}	Virtual junction temperature	Blocking V _{DRM} / _{VRRM}		-	125	°C
T _{stg}	Storage temperature range			-55	125	°C
F _m	Clamping force			48.0	59.0	kN





DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditio	Test Conditions		Max.	Units
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125°C		-	200	mA
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V _{DRM} , T _j = 125°C, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% V _{DRM} to 2x I _{T(AV)}	Repetitive 50Hz	-	150	A/µs
		Gate source 30V, 10Ω , $t_r < 0.5\mu s$, $T_j = 125^{\circ}C$	Non-repetitive	-	300	A/µs
V _{T(TO)}	Threshold voltage – Low level	500A to 2000A at T _{case} = 125	5°C	-	0.90	V
	Threshold voltage – High level	2000A to 7200A at T _{case} = 125°C		-	1.1	V
r _T	On-state slope resistance – Low level	500A to 2000A at T _{case} = 125°C		-	0.3428	mΩ
	On-state slope resistance – High level	2000A to 7200A at T _{case} = 125°C		-	0.2414	mΩ
t _{gd}	Delay time	$V_D = 67\% \ V_{DRM}$, gate source 30V, 10Ω $t_r = 0.5 \mu s$, $T_j = 25^{\circ} C$		-	3	μs
tq	Turn-off time	T_j = 125°C, V_R = 200V, dI/dt = 1A/ μ s, dV_{DR}/dt = 20V/ μ s linear		-	600	μs
Qs	Stored charge	$I_T = 2000A$, $T_j = 125$ °C, $dI/dt - 1A/\mu s$,		2000	4750	μC
IL	Latching current	$T_j = 25^{\circ}C, V_D = 5V$		-	3	А
l _H	Holding current	$T_j = 25^{\circ}C, R_{G-K} = \infty, I_{TM} = 50^{\circ}$	0A, I _T = 5A	-	300	mA





GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Parameter Test Conditions		Units
V_{GT}	Gate trigger voltage	$V_{DRM} = 5V$, $T_{case} = 25$ °C	1.5	V
V_{GD}	Gate non-trigger voltage	At 50% V _{DRM} , T _{case} = 125°C	0.4	V
I _{GT}	Gate trigger current	$V_{DRM} = 5V$, $T_{case} = 25$ °C	350	mA
I _{GD}	Gate non-trigger current	At 50% V _{DRM} , T _{case} = 125°C	15	mA

CURVES

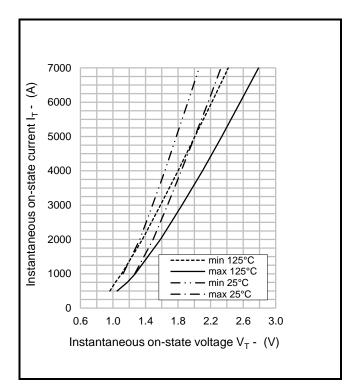


Fig.2 Maximum & minimum on-state characteristics

V_{TM} EQUATION

 $V_{TM} = A + BIn (I_T) + C.I_T + D.\sqrt{I_T}$

Where A = -0.450546

B = 0.251217

C = 0.000242

D = -0.008134

these values are valid for $T_j = 125$ °C for $I_T 500A$ to 7200A

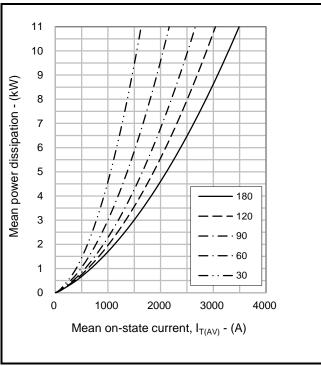


Fig.3 On-state power dissipation - sine wave

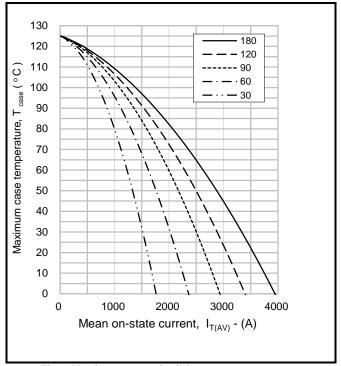


Fig.4 Maximum permissible case temperature, double side cooled – sine wave

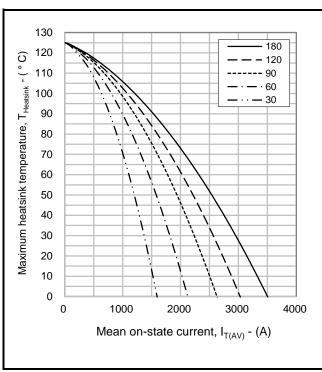


Fig.5 Maximum permissible heatsink temperature, double side cooled – sine wave

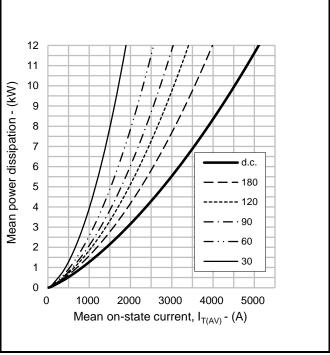
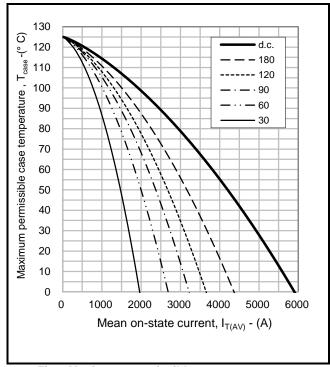
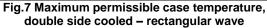


Fig.6 On-state power dissipation - rectangular wave





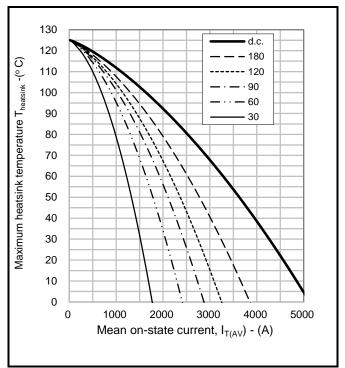
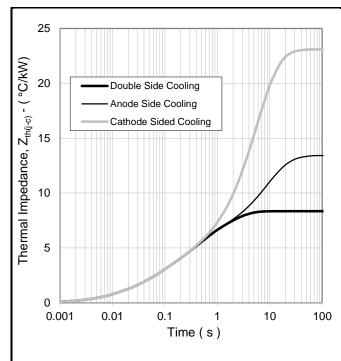


Fig.8 Maximum permissible heatsink temperature, double side cooled - rectangular wave



		1	2	3	4
Double side cooled	R _i (°C/kW)	0.612	1.7721	3.1053	2.8608
	T _i (s)	0.010332	0.056415	0.333082	1.6323
Anode side cooled	R _i (°C/kW)	0.7009	1.9388	3.61	7.1383
	T _i (s)	0.011328	0.065993	0.419695	9.0612
Cathode side coole	R _i (°C/kW)	0.6728	2.0168	1.7306	18.6391
	T _i (s)	0.010954	0.065544	0.30379	5.7274

 $Z_{th} = \sum [R_i x (1-exp. (t/t_i))]$ [1]

 $\Delta R_{\text{th(j-c)}}$ Conduction

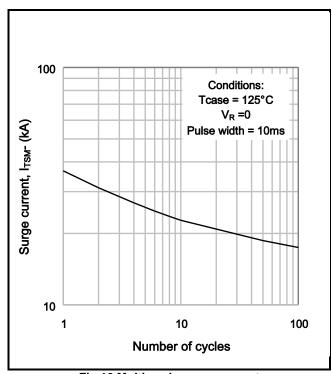
Tables show the increments of thermal resistance $R_{\text{th}(j\text{-}c)}$ when the device operates at conduction angles other than d.c.

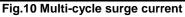
D	Double side cooling				
	$_{\Delta}Z_{th}$	(z)			
θ°	sine.		θ°		
180	0.94	0.65		180	
120	1.09	0.92		120	
90	1.24	1.07		90	
60	1.38	1.23		60	
30	1.49	1.40		30	
15	1.54	1.49		15	

Anode Side Cooling				Anode Side Cooling Cathode Sided Coo				
	ΔZ_t	_h (z)			ΔZ_{tl}	n (z)		
θ°	sine.	rect.	Ī	θ°	sine.	rect.		
180	0.94	0.64		180	0.94	0.64		
120	1.08	0.91		120	1.08	0.91		
90	1.23	1.06		90	1.24	1.06		
60	1.37	1.22		60	1.37	1.22		
30	1.47	1.38		30	1.48	1.39		
15	1 52	1 47		15	1.53	1 48		

Catr	<u>iode Sided Cooling</u>		
	ΔZ_{th} (z)		
θ°	sine.	rect.	
180	0.94	0.64	
120	1.08	0.91	
90	1.24	1.06	
60	1.37	1.22	
30	1.48	1.39	
15	1.53	1 48	

Fig.9 Maximum (limit) transient thermal impedance - junction to case (°C/kW)





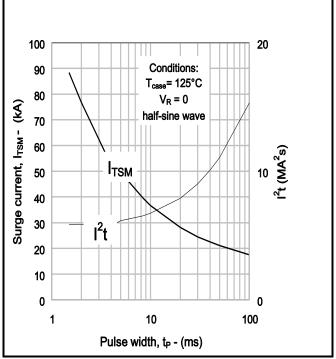


Fig.11 Single-cycle surge current

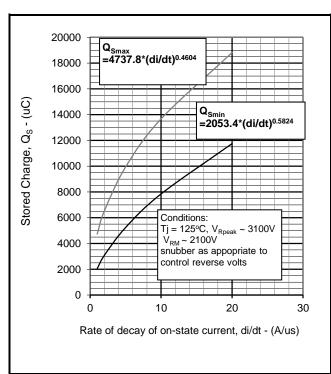


Fig.12 Stored charge

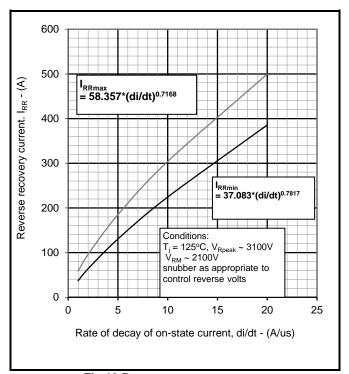


Fig.13 Reverse recovery current

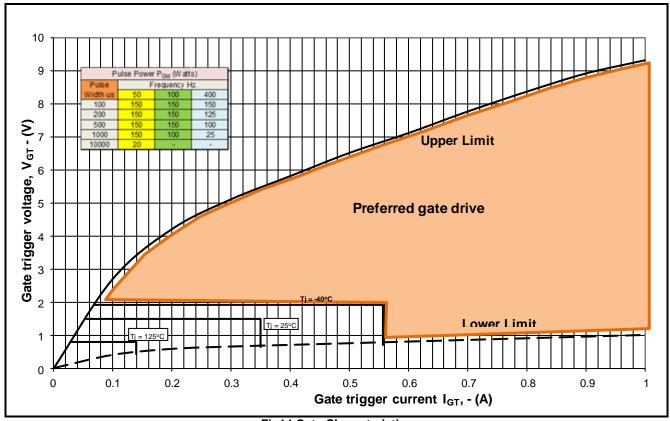


Fig14 Gate Characteristics

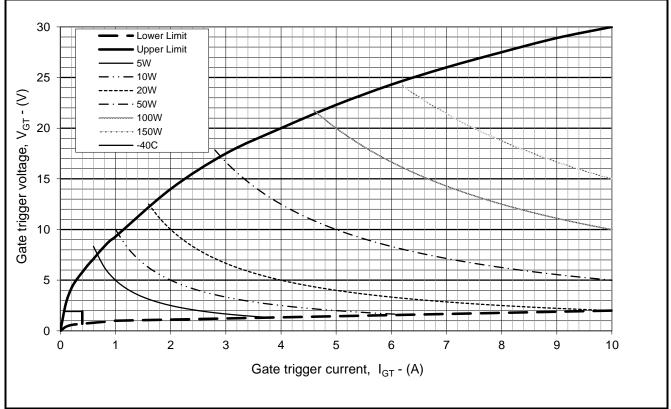


Fig. 15 Gate characteristics



PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.

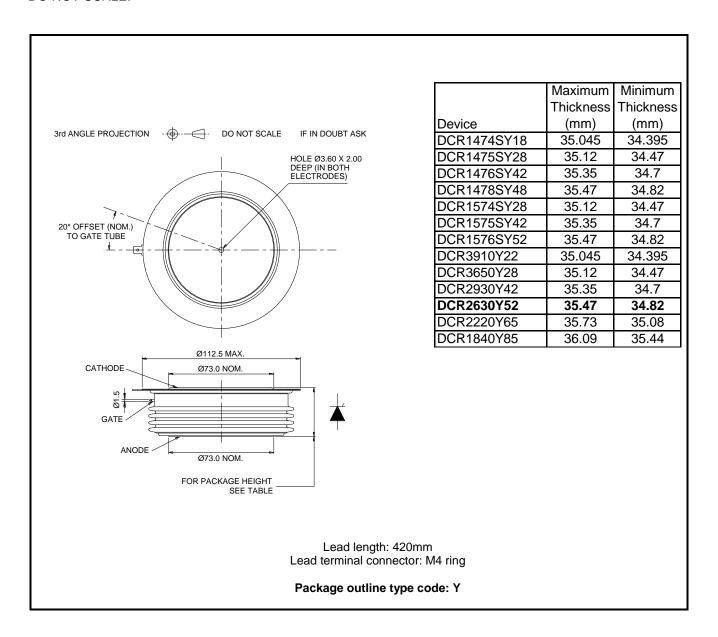


Fig.16 Package outline





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